

Title (en)

System for checking wiring configuration of printed circuit board

Title (de)

System zur Prüfung der Verdrahtungs-Konfiguration von gedruckten Leiterplatten

Title (fr)

Système pour vérifier la configuration de câblage de cartes à circuits imprimés

Publication

EP 1160696 A2 20011205 (EN)

Application

EP 01113106 A 20010529

Priority

- JP 2000166401 A 20000602
- JP 2000238188 A 20000807

Abstract (en)

Layout of a high-speed signal wiring on a power supply plane is checked and specified at an optimum position capable of minimizing a spurious electromagnetic radiation so as not to affect other wiring layers. When a high speed signal line which is an object to be checked exists on a power supply plane, a perpendicular distance between the high speed signal line and the plane which is nearest to the signal line is determined, and compared with a minimum required distance computed therefor in advance on the basis of its circuit specification of the high speed signal line. If the perpendicular distance determined does not exceed the minimum required distance computed, an appropriate message corresponding to the name of the high speed signal line is displayed. <IMAGE>

IPC 1-7

G06F 17/50

IPC 8 full level

G01R 29/08 (2006.01); **G06F 17/50** (2006.01); **H05K 3/00** (2006.01)

CPC (source: EP US)

G06F 30/394 (2020.01 - EP US); **G06F 30/398** (2020.01 - EP US)

Cited by

FR2846494A1; CN109709421A; EP1972433A1

Designated contracting state (EPC)

DE FR GB

DOCDB simple family (publication)

EP 1160696 A2 20011205; **EP 1160696 A3 20050817**; **EP 1160696 B1 20070124**; DE 60126183 D1 20070315; DE 60126183 T2 20080214; JP 2002056043 A 20020220; JP 4341152 B2 20091007; US 2002019970 A1 20020214; US 6799306 B2 20040928

DOCDB simple family (application)

EP 01113106 A 20010529; DE 60126183 T 20010529; JP 2000238188 A 20000807; US 87295501 A 20010601